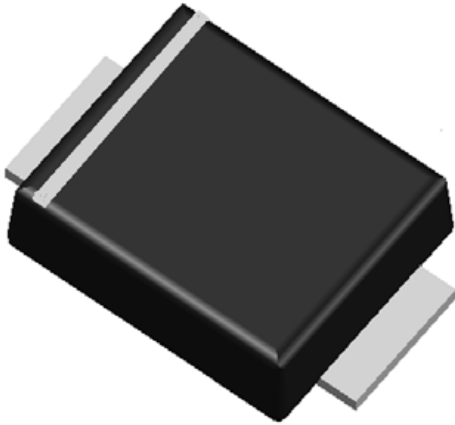


Surface Mount Schottky Rectifier

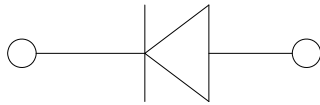


Features

- Low profile package
- Ideal for automated placement
- Guardring for overvoltage protection
- Low power losses, high efficiency
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C

Typical Applications

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.



Mechanical Data

- **Package:** SMBF
Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant, halogen-free
- **Terminals:** Tin plated leads, solderable per J-STD-002 and JESD22-B102
- **Polarity:** Cathode line denotes the cathode end

■ Maximum Ratings (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	SS52BF	SS53BF	SS54BF	SS55BF	SS56BF	SS58BF	SS510BF	SS515BF	SS520BF
Device marking code			SS52BF	SS53BF	SS54BF	SS55BF	SS56BF	SS58BF	SS510BF	SS515BF	SS520BF
Repetitive peak reverse voltage	V _{RRM}	V	20	30	40	50	60	80	100	150	200
Average rectified output current @60Hz sine wave, resistance load, TL (FIG.1)	I _O	A	5.0								
Surge(non-repetitive)forward current @60Hz half-sine wave,1 cycle, Ta=25°C	I _{FSM}	A	100								
Storage temperature	T _{stg}	°C	-55 ~+150								
Junction temperature	T _j	°C	-55~+125				-55 ~+150				

■ Electrical Characteristics (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	SS52BF	SS53BF	SS54BF	SS55BF	SS56BF	SS58BF	SS510BF	SS515BF	SS520BF
Maximum instantaneous forward voltage drop per diode	V _F	V	I _{FM} =5.0A	0.60			0.70		0.85		0.90	
Maximum DC reverse current at rated DC blocking voltage per diode @ V _{RM} =V _{RRM}	I _{RRM}	mA	Ta=25°C	0.5				0.1				
			Ta=100°C	10				5				

Note1:Pulse test:300uS pulse width,1% duty cycle

Note2:Pulse test:pulse width 40mS



SS52BF THRU SS520BF

■ Thermal Characteristics (T_a=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	SS52BF	SS53BF	SS54BF	SS55BF	SS56BF	SS58BF	SS510BF	SS515BF	SS520BF
Typical Thermal Resistance	R _{θJ-A}	°C/W	58								
	R _{θJ-L}		20								
	R _{θJ-C}		15								

Note:
 (1) Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.6" x 0.6" (16 mm x 16 mm) copper pad areas

■ Characteristics(Typical)

FIG1: I_o-T_L Curve

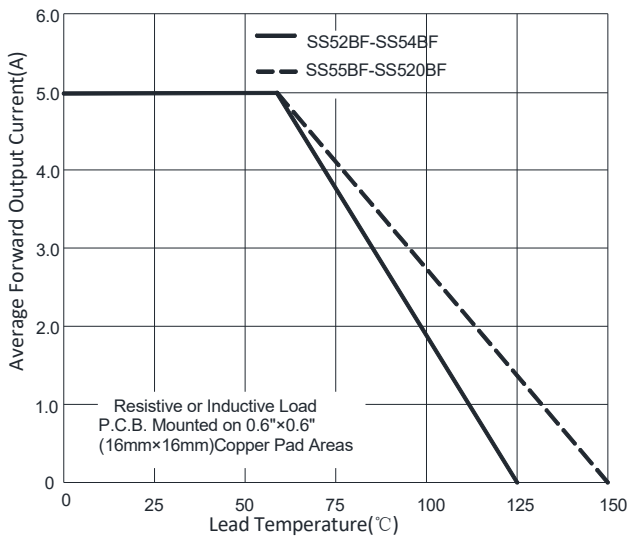


FIG2: Surge Forward Current Capability

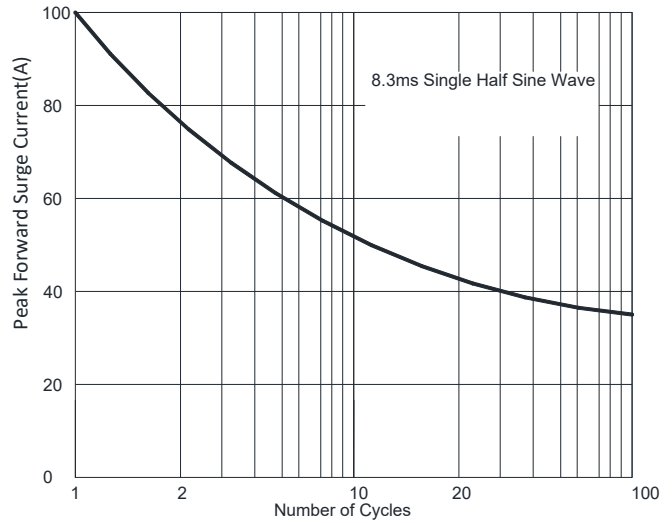


FIG3: Forward Voltage

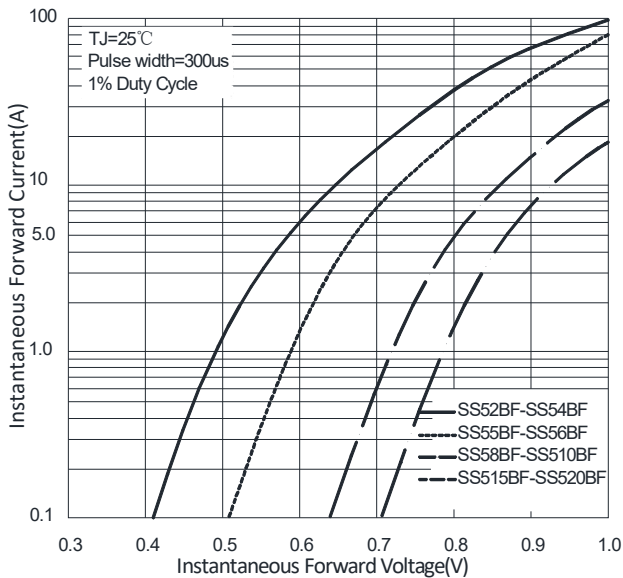
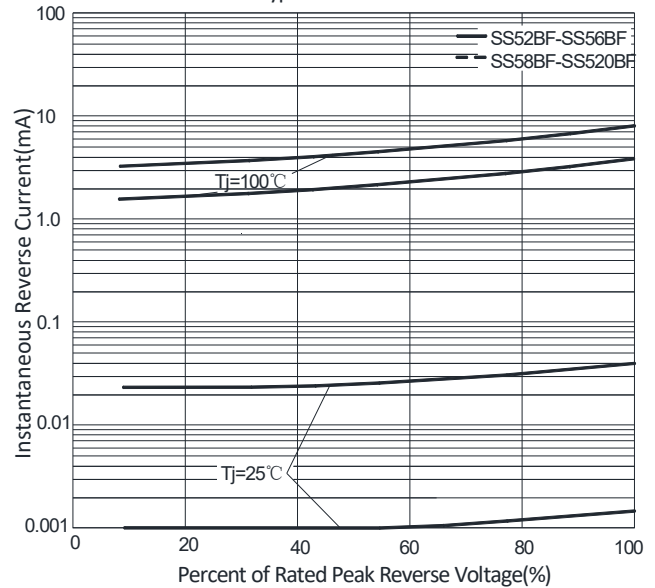


FIG4: Typical Reverse Characteristics



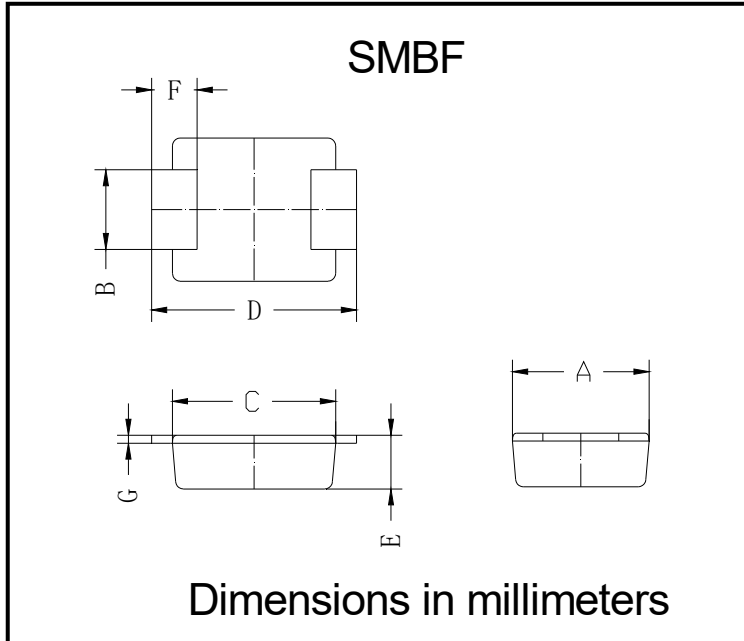


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■ Ordering Information (Example)

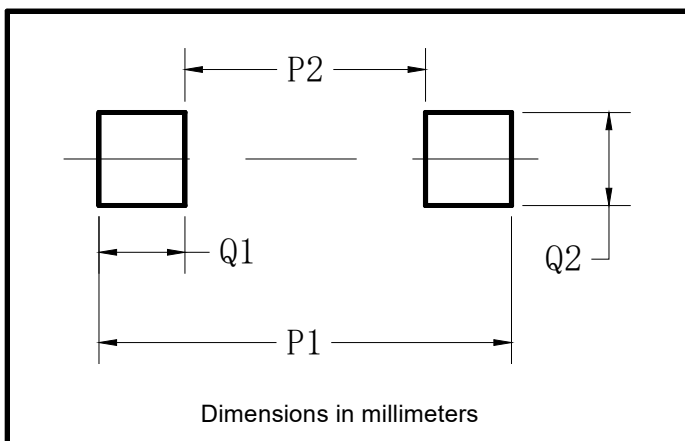
PREFERED P/N	PACKING CODE	UNIT WEIGHT(g)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
SS52BF-SS520BF	F1	Approximate 0.065	5000	/	80000	13" reel

■ Outline Dimensions



SMBF		
Dim	Min	Max
A	3.40	3.80
B	1.90	2.10
C	4.15	4.45
D	5.10	5.60
E	1.05	1.55
F	0.70	1.35
G	0.15	0.25

■ Suggested Pad Layout



Dim	Millimeters
P1	6.20
P2	2.40
Q1	1.90
Q2	2.20



SS52BF THRU SS520BF

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